<u>MOSFET</u> – Power, P-Channel, SOT-23

-20 V, -400 mA

Features

- Low $R_{DS(on)}$ Provides Higher Efficiency and Extends Battery Life R_{DSon} = 0.80 $\Omega,\,V_{GS}$ = -10~V
 - $R_{DSon} = 1.10 \ \Omega, \ V_{GS} = -4.5 \ V$
- Miniature SOT-23 Surface Mount Package Saves Board Space
- NVT Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- DC-DC Converters
- Computers
- Printers
- PCMCIA Cards
- Cellular and Cordless Telephones

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Symbol	Value	Unit	
V _{DSS}	-20	V	
V _{GS}	±20	V	
I _D I _{DM}	-0.4 -1.0	A	
PD	225	mW	
T _J , T _{stg}	– 55 to 150	°C	
R _{0JA}	556	°C/W	
۱ _S	0.4	А	
ΤL	260	°C	
	V _{DSS} V _{GS} I _D I _{DM} P _D T _J , T _{stg} R _{θJA} I _S	$\begin{array}{c c} V_{DSS} & -20 \\ V_{GS} & \pm 20 \\ I_D & -0.4 \\ I_{DM} & -1.0 \\ P_D & 225 \\ T_J, T_{stg} & -55 \text{ to} \\ 150 \\ R_{\theta JA} & 556 \\ I_S & 0.4 \\ \end{array}$	

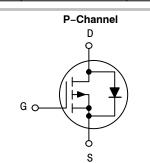
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.



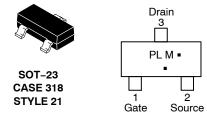
ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	R _{DS(on)} Typ I _D MAX	
–20 V	550 mΩ @ –10 V	–400 mA	



MARKING DIAGRAM & PIN ASSIGNMENT



PL = Specific Device Code

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTR0202PLT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
NTR0202PLT3G	SOT-23 (Pb-Free)	10000 / Tape & Reel
NVTR0202PLT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						•
$\begin{array}{l} \mbox{Drain-to-Source Breakdown Voltage} \\ (V_{GS} = 0 \mbox{ V, } I_D = -10 \mu \mbox{A}) \\ (\mbox{Positive Temperature Coefficient}) \end{array}$		V _{(BR)DSS}	-20	33		V mV/°C
Zero Gate Voltage Drain Current $(V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 25^{\circ}\text{C})$ $(V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 150^{\circ}\text{C})$		I _{DSS}			-1.0 -10	μΑ
Gate-Body Leakage Current (V_{GS} = \pm 20 V, V_{DS} = 0 V)		I _{GSS}			±100	nA
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage $(V_{DS} = V_{GS}, I_D = -250 \ \mu\text{A})$ (Negative Temperature Coefficient	t)	V _{GS(th)}	-1.1	-1.9 3.0	-2.3	V mV/°C
Static Drain-to-Source On-Resistance $(V_{GS} = -10 \text{ V}, I_D = -200 \text{ mA})$ $(V_{GS} = -4.5 \text{ V}, I_D = -50 \text{ mA})$		R _{DS(on)}		0.55 0.80	0.80 1.10	Ω
Forward Transconductance $(V_{DS} = -10 \text{ V}, \text{ I}_{D} = -200 \text{ mA})$		9 _{fs}		0.5		Mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance		C _{iss}		70		pF
Output Capacitance	(V _{DS} = −5.0 V, V _{GS} = 0 V, F = 1.0 MHz)	C _{oss}		74		
Reverse Transfer Capacitance	,	C _{rss}		26		
SWITCHING CHARACTERISTICS (I	Note 3)					
Turn-On Delay Time		t _{d(on)}		3.0		ns
Rise Time	(V _{DD} = −15 V, I _D = −200 mA,	t _r		6.0		
Turn-Off Delay Time	$V_{GS} = -10 \text{ V}, \text{ R}_{G} = 6.0 \Omega$	t _{d(off)}		18		
Fall Time		t _f		4		
Total Gate Charge	(V _{DS} = -15 V, I _D = -200 mA, V _{GS} = -10 V)	Q _{TOT}		2.18		nC
Gate-Source Charge		Q _{GS}		0.41		
Gate-Drain Charge		Q _{GD}		0.40		
BODY-DRAIN DIODE CHARACTER	RISTICS (Note 2)					
	50°C)	V _{SD}		-0.8 -0.65	-1.0	V
Reverse Recovery Time		t _{rr}		11.8		ns
	$(I_{S} = -1.0 \text{ A}, V_{GS} = 0 \text{ V}, \\ dI_{S}/dt = 100 \text{ A}/\mu s)$	ta		9		
		t _b		3]

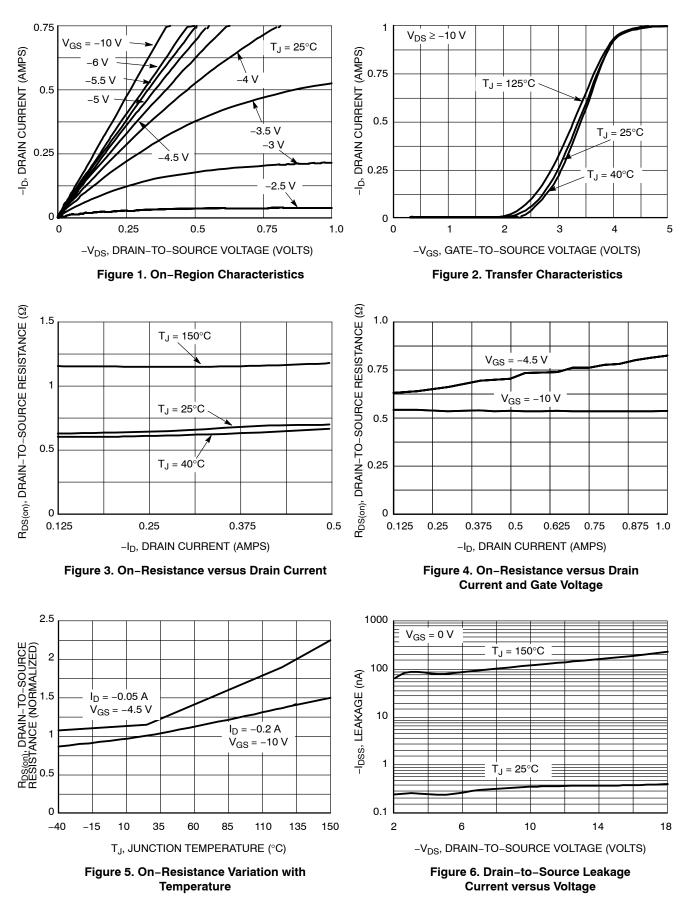
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperature.

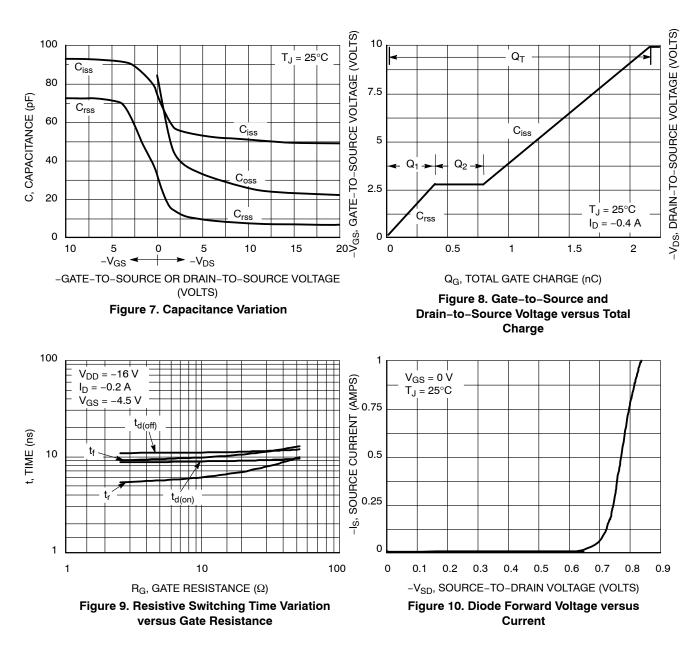
 $\mathsf{Q}_{\mathsf{R}\mathsf{R}}$

0.007

μC

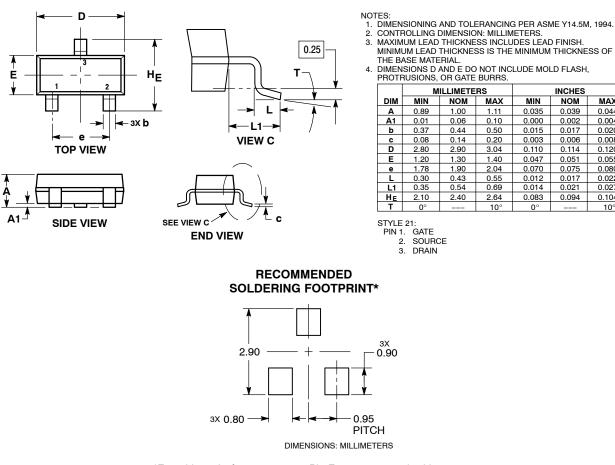
Reverse Recovery Stored Charge





PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AR**



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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